# VS-EBU15006-F4

**Vishay Semiconductors** 

# FRED Pt<sup>®</sup> Ultrafast Soft Recovery Diode, 150 A



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PRODUCT SUMMARY			
Package	PowerTab <sup>®</sup>		
I <sub>F(AV)</sub>	150 A		
V <sub>R</sub>	600 V		
V <sub>F</sub> at I <sub>F</sub>	1.08 V		
t <sub>rr</sub> (typ.)	50 ns		
T <sub>J</sub> max.	175 °C		
Diode variation	Single die		

### FEATURES

- Ultrafast recovery time
- 175 °C max. operating junction temperature
- Screw mounting only
- Designed and qualified according to JEDEC®-JESD 47
- PowerTab<sup>®</sup> package
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### BENEFITS

- Reduced RFI and EMI
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

### **DESCRIPTION/APPLICATIONS**

These diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems.

The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for HF welding, power converters and other applications where switching losses are not significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Cathode to anode voltage	V <sub>R</sub>		600	V		
Continuous forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 89 °C	150	•		
Single pulse forward current	I <sub>FSM</sub>	T <sub>C</sub> = 25 °C	1200	A		
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C		

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 200 μA	600	-	-	
		I <sub>F</sub> = 150 A	-	1.27	1.63	v
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 150 A, T <sub>J</sub> = 125 °C	-	1.15	1.43	
		I <sub>F</sub> = 150 A, T <sub>J</sub> = 175 °C	-	1.08	1.32	
Reverse leakage current I <sub>R</sub>		$V_{R} = V_{R}$ rated	-	-	8	μA
		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	0.5	mA
Junction capacitance	CT	V <sub>R</sub> = 600 V	-	70	-	pF
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body - 3.5 -		nH		

Revision: 16-Jun-15

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Document Number: 94907

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<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
			$I_F$ = 1.0 A, dI <sub>F</sub> /dt = 100 A/µs, V <sub>R</sub> = 30 V		50	-	
Powerze recovery time	+	$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	40	-	
Reverse recovery time t <sub>rr</sub>	۲r	T <sub>J</sub> = 25 °C		-	100	-	ns
		T <sub>J</sub> = 125 °C		-	210	-	
Peak recovery current I <sub>RRM</sub>	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 50 A V <sub>B</sub> = 200 V	-	10.5	-	А	
	IRRM	T <sub>J</sub> = 125 °C	v <sub>R</sub> = 200 v dl⊧/dt = 200 A/µs	-	22	-	A
Reverse recovery charge Q <sub>rr</sub>	0	T <sub>J</sub> = 25 °C		-	550	-	nC
	T <sub>J</sub> = 125 °C		-	2350	-	nc	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	0.35	K/W
Typical thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	-	0.2	-	r./ vv
Weight			-	-	5.02	g
weight			-	0.18	-	oz.
Mounting torque			1.2 (10)	-	2.4 (20)	kgf · cm (lbf · in)
Marking device		Case style PowerTab <sup>®</sup>	EBU15006			



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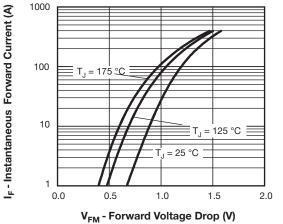


Fig. 1 - Maximum Forward Voltage Drop Characteristics

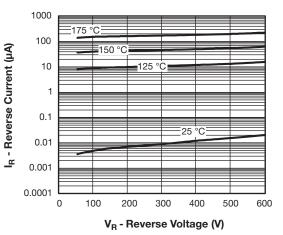


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

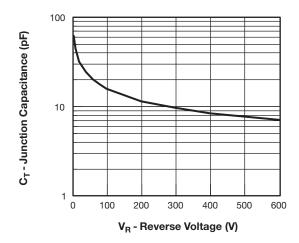


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

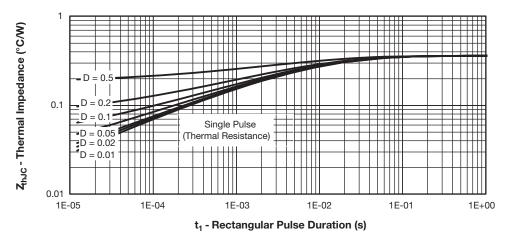
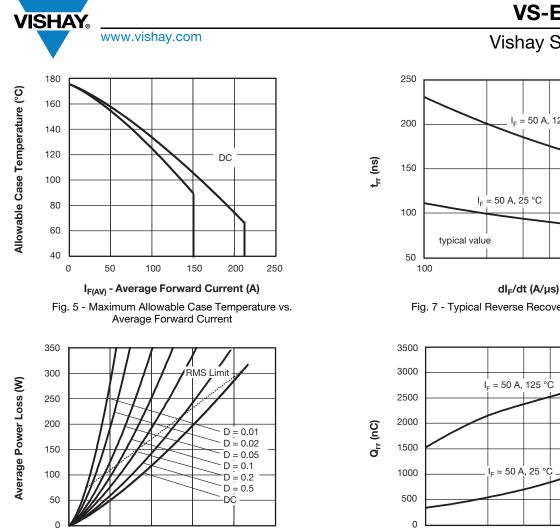


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics



I<sub>F(AV)</sub> - Average Forward Current (A) Fig. 6 - Forward Power Loss Characteristics

150

200

250

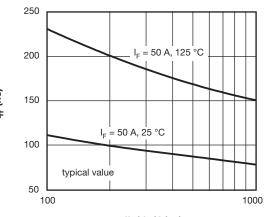
100

50

0



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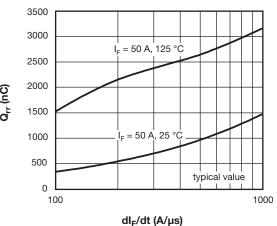


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

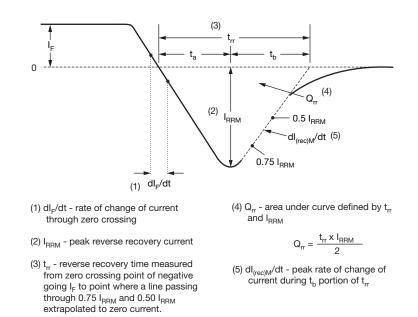


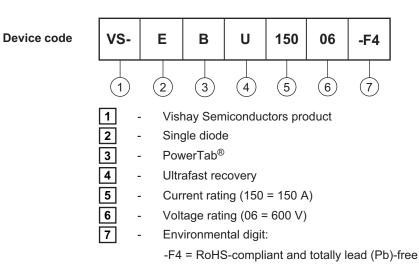
Fig. 9 - Reverse Recovery Waveform and Definitions

Revision: 16-Jun-15	4	Document Number: 94907
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### **ORDERING INFORMATION TABLE**



ORDERING INFORMATION (Example)						
PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION						
VS-EBU15006-F4	25	375	Antistatic plastic tube			

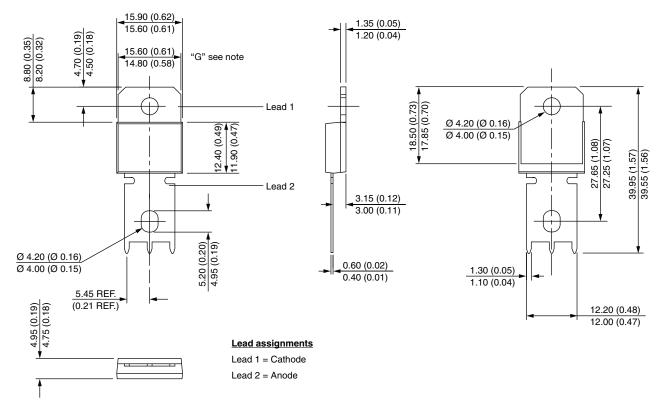
LINKS TO RELATED DOCUMENTS			
Dimensions www.vishay.com/doc?95240			
Part marking information	www.vishay.com/doc?95467		
Application note	www.vishay.com/doc?95179		



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**PowerTab**<sup>®</sup>

#### **DIMENSIONS** in millimeters (inches)



Note:

Outline conform to JEDEC® TO-275, except for dimension "G" only



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